

HOSTAFORM® C 9021 SW XAP® 2 LS

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Chemical abbreviation according to ISO 1043-1: POM-KD10

Molding compound ISO 29988-POM-K,KD10,GLNRS2,3-2

POM copolymer Injection molding type, special modified with anti-friction additives for prevention of squeaking noise; good chemical resistance to solvents, fuel and strong alkalis as well as good hydrolysis resistance; high resistance to thermal and oxidative degradation. Ranges of applications: For sliding combinations with low wear and low coefficient of friction, prevents squeaking noise. Burning rate ISO 3795 and FMVSS 302 < 100 mm/min for a thickness more than 1,5 mm. Reduced emission grade. Emissions according to VDA 275 < 5 mg/kg Preliminary Datasheet

Product information

Resin Identification	POM-KD10	ISO 1043
Part Marking Code	>POM-KD10<	ISO 11469

Rheological properties

Melt volume-flow rate	7 cm ³ /10min	ISO 1133
Temperature	190 °C	
Load	2.16 kg	

Typical mechanical properties

Tensile modulus	2700 MPa	ISO 527-1/-2
Tensile stress at yield, 50mm/min	52 MPa	ISO 527-1/-2
Tensile strain at yield, 50mm/min	7 %	ISO 527-1/-2
Nominal strain at break	16 %	ISO 527-1/-2
Flexural modulus	2600 MPa	ISO 178
Flexural strength	63 MPa	ISO 178
Charpy impact strength, 23°C	90 kJ/m ²	ISO 179/1eU
Charpy impact strength, -30°C	85 kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C	4 kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30°C	4 kJ/m ²	ISO 179/1eA
Ball indentation hardness, H 358/30	135 MPa	ISO 2039-1
Poisson's ratio	0.38 ^[C]	

[C]: Calculated

Thermal properties

Melting temperature, 10°C/min	166 °C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	80 °C	ISO 75-1/-2
Coefficient of linear thermal expansion (CLTE), parallel	120 E-6/K	ISO 11359-1/-2

Flammability

FMVSS Class	B	ISO 3795 (FMVSS 302)
Burning rate, Thickness 2 mm	58.8 mm/min	ISO 3795 (FMVSS 302)

Physical/Other properties

Density	1420 kg/m ³	ISO 1183
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Injection

Drying Recommended	no
Drying Temperature	100 °C
Drying Time, Dehumidified Dryer	3 - 4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	200 °C
Min. melt temperature	190 °C
Max. melt temperature	210 °C
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	100 °C
Min. mould temperature	80 °C
Max. mould temperature	120 °C
Hold pressure range	60 - 120 MPa
Back pressure	2 MPa

Characteristics

Processing	Injection Moulding, Other Extrusion
Delivery form	Pellets
Additives	Release agent
Special characteristics	U.V. stabilised or stable to weather, Low wear / Low friction, Low emissions

Additional information

Processing Notes

Storage

The product can then be stored in standard conditions until processed.

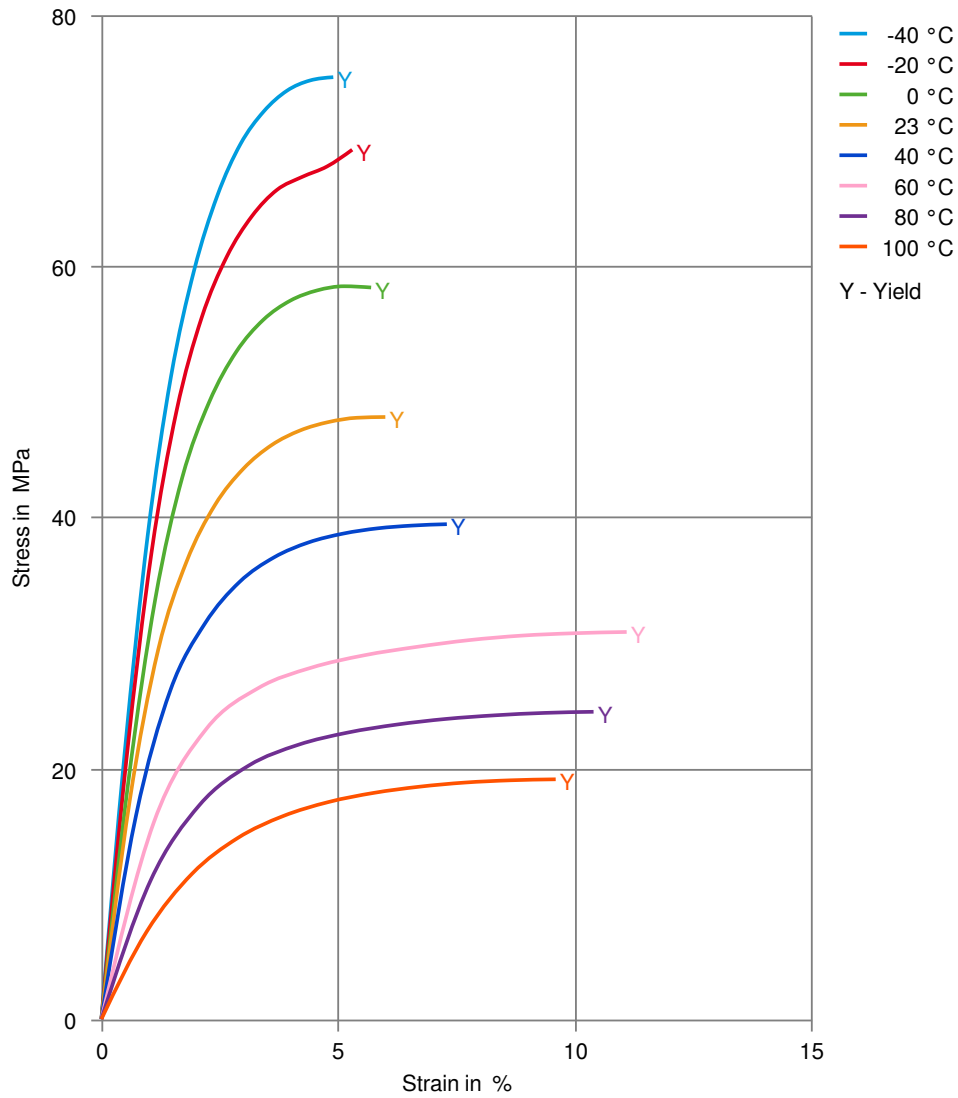
Automotive

OEM	STANDARD	ADDITIONAL INFORMATION
Mercedes-Benz	DBL5404	BQF

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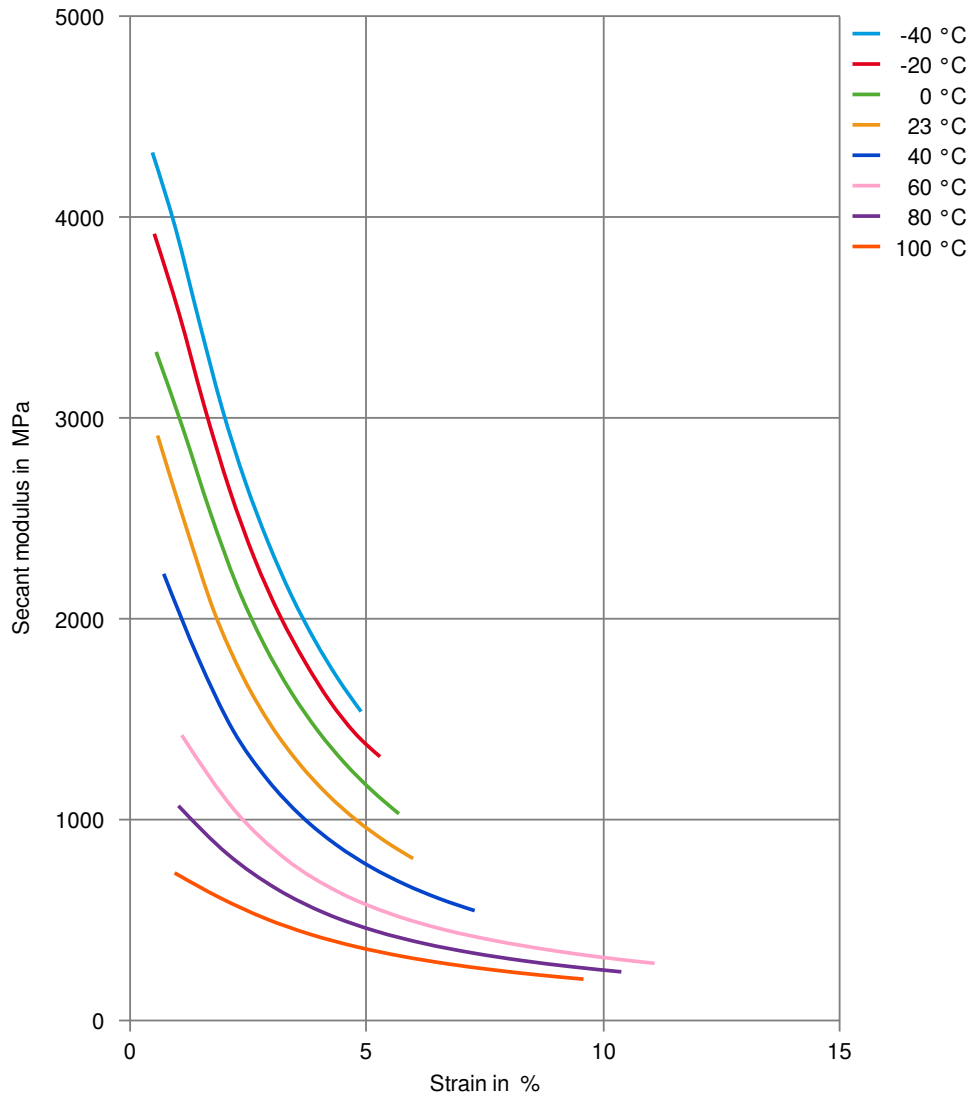
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Stress-strain



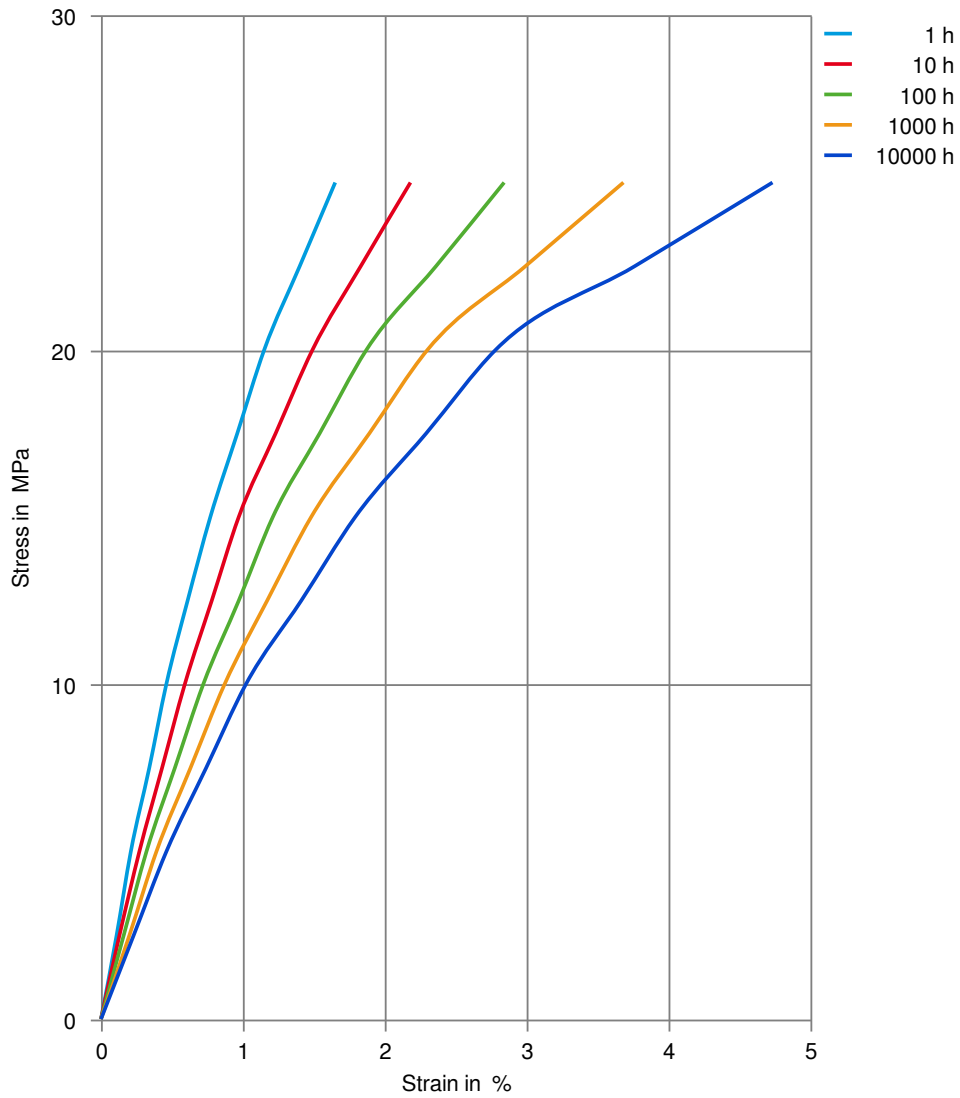
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Secant modulus-strain



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Stress-strain (isochronous) 23°C



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Creep modulus-time 23°C

